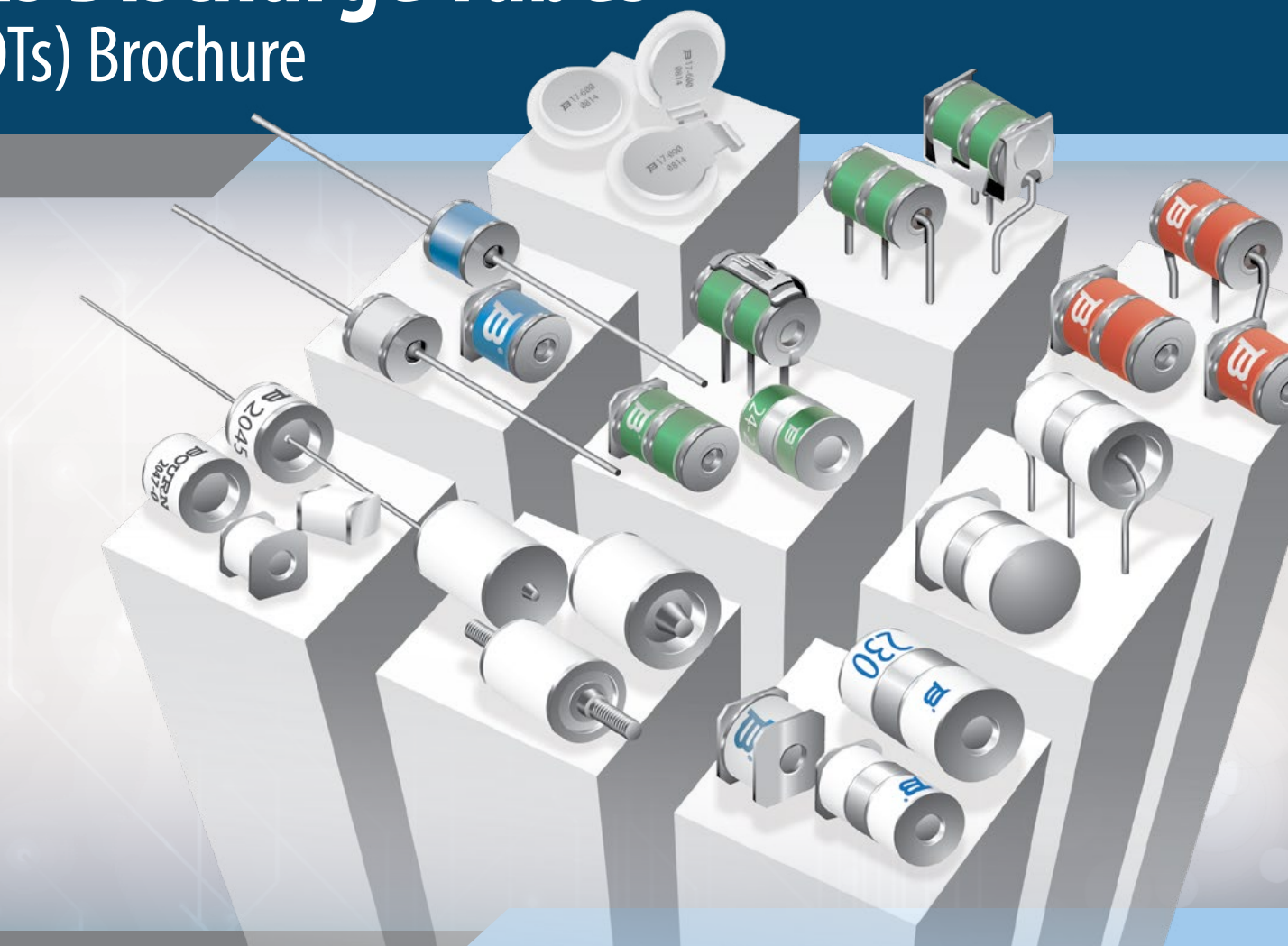




Gas Discharge Tubes (GDTs) Brochure



BOURNS®

Bourns® GDT Product Overview



Introduction

Bourns delivers a comprehensive line of circuit protection technologies and solutions. At our engineering centers in Riverside, California and Linkou, Taiwan, we design a full range of overvoltage and overcurrent protection technologies.

Bourns offers world-class technology and application expertise that is the result of many years of circuit protection engineering, design and support. Bourns' global reputation for extensive application knowledge, quality products, innovative protection strategies and a wide range of technologies ensures that we can provide the right circuit protection solution for your needs.

Customers across different markets and industries have come to rely on Bourns® Gas Discharge Tube (GDT) Surge Arrestors to protect an ever-increasing variety of electronic equipment. Bourns® GDT technology offers fast response times, low capacitance, long service life and high surge current handling capabilities. Bourns engineers continue to innovate GDT technology by designing ground-breaking GDT designs such as the industry-leading GDT Series with FLAT® technology.

Bourns® GDT Product Features

- RoHS compliant*
- Wide range of voltages available (75 V to 7200 V)
- Wide range of sizes available
- Patented hybrid technology designs (MSP® GDT)
- Low arc (on-state) voltage
- Low capacitance and insertion loss
- Non-radioactive materials
- Devices are tested according to U.S.A. and International standards and recommendations
- Low work function designs that result in long and stable service life
- Patented Switch-Grade Fail-Short technology available on some models

Bourns® GDT Benefits

- 50+ years of designing and manufacturing GDT devices
- Impulse current ratings (2 kA to 100 kA)
- Low capacitance and insertion loss
- Designs based on industry standards
- Switch-Grade Fail-Short technology available on some models
- Technical committee participation and leadership
- Custom device capabilities
- Lab facilities available for design verification of customer circuits as well as with testing capabilities for UL and Telcordia standards

Benefits of Partnering with Bourns for your GDT Circuit Protection Needs

- Special leadform and voltage screening capabilities
- Technical design support
- Bourns offers multiple circuit protection components for total design support including Thyristors, Diodes, Multifuse® PPTCs, CPTCs, TBU® High-Speed Protectors, Telefuse™ Telecom Protectors, MOVs and Magnetics.

GDT Operation

GDT surge arrester devices are designed to operate on the gas-physical principle of the highly effective arc discharge. Essentially a voltage dependent switch, the GDT maintains a high impedance off-state until a voltage exceeds the device's sparkover voltage. At this point, the gas in the GDT becomes fully ionized and conduction takes place within a fraction of a microsecond.

During arc-over, the GDT exhibits the low impedance of a crowbar device resulting in very low on-state voltage (arc voltage). The crowbar effect of the GDT effectively limits the overvoltage to a low level and shunts the associated follow current away from downstream components and circuitry. When the surge event subsides and the system voltage returns to normal levels, the GDT will reset into its high impedance (off) state.

Switch-Grade Fail-Short Devices

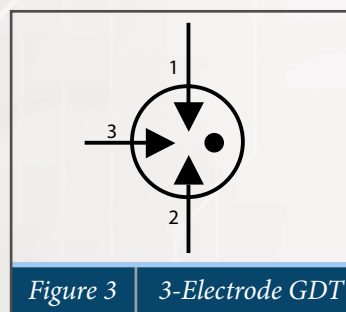
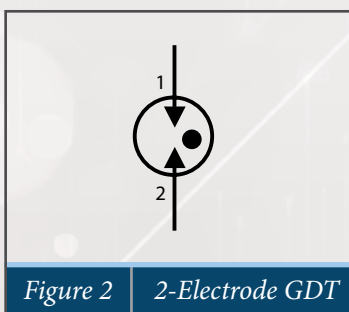
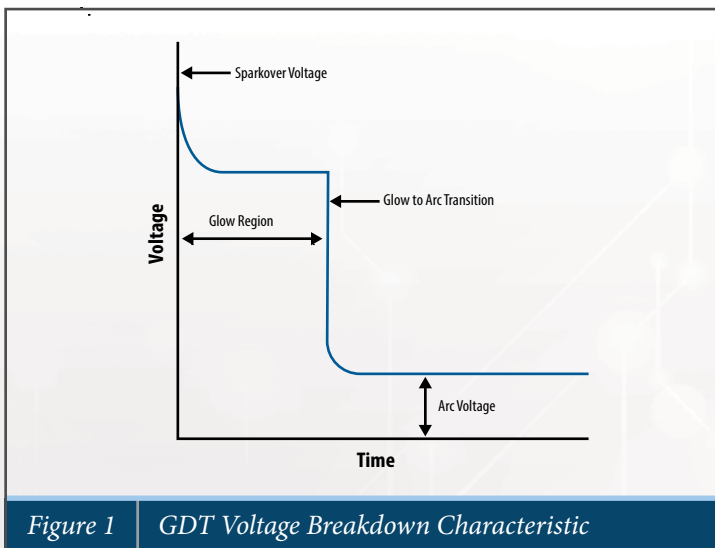
Bourns offers a Switch-Grade Fail-Short mechanism available on selected Bourns® GDTs.

- The fail-short contacts are spring-loaded switch-grade electrical conductors with no insulating burn through media or solder pellets under compression.
- The fail-short mechanism is activated by a breakaway action, preventing solder residues from freezing the fail-short mechanism and diurnal temperature failures.
- Superior thermal coupling between the Switch-Grade Fail-Short device and suppression components allows rapid Fail-Short activation in both vented and non-vented GDTs, with one of the industry's lowest contact resistance.
- Available on Model 2026, 2036 and 2026 MSP® GDTs.

GDT Types

Bourns offers a broad range of 2-electrode and 3-electrode GDT devices (figures 2 & 3). 2-Electrode devices are typically used to provide line to ground or line to line protection (1 to 2). In a single device, a 3-electrode GDT can provide protection from line to line (1-2) as well as line to ground (1 to 3, 2 to 3) in a single device.

Standard GDTs (75 to 600 V) are provided in both 2- and 3-electrode devices. High voltage GDTs (800 to 7200 V) are primarily offered in 2-electrode devices and some select 3-electrode packages. In addition, specialized GDTs are offered in high current, fast acting, hybrid and FLAT® technology versions allowing the customer to address a wider array of protection needs.



Bourns® GDT Application Overview

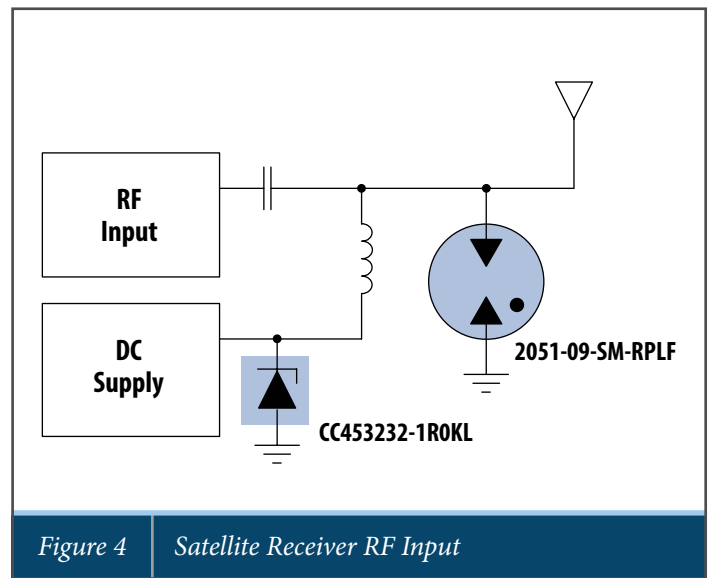


Figure 4 Satellite Receiver RF Input

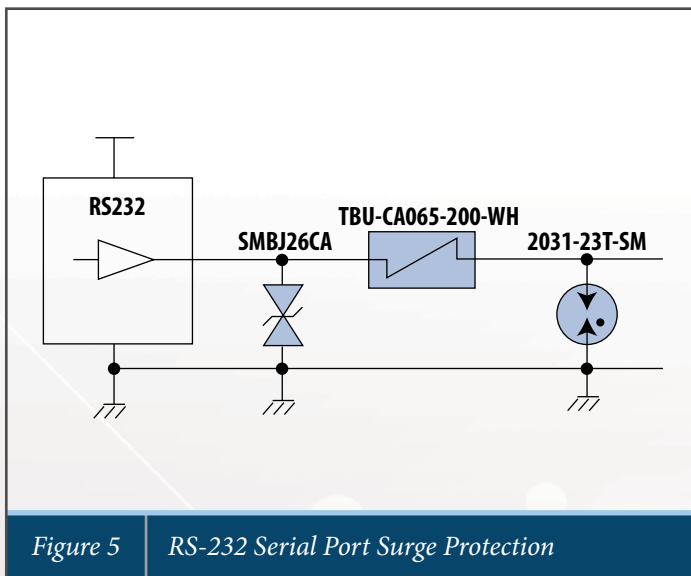


Figure 5 RS-232 Serial Port Surge Protection

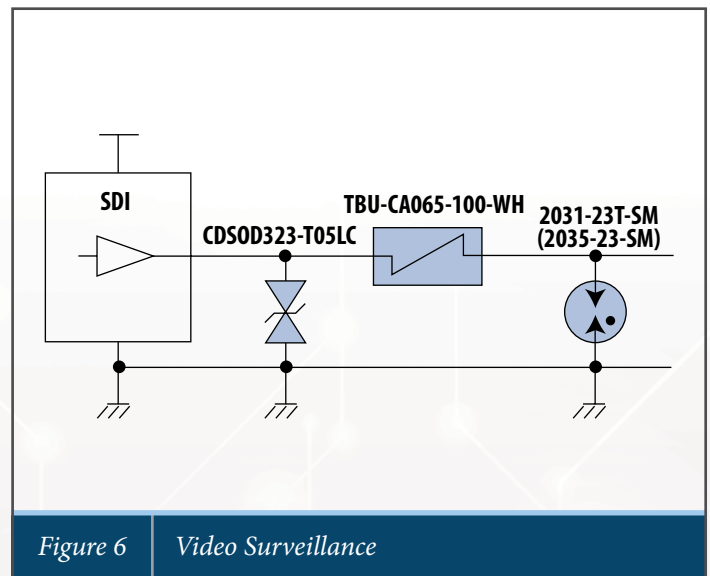


Figure 6 Video Surveillance

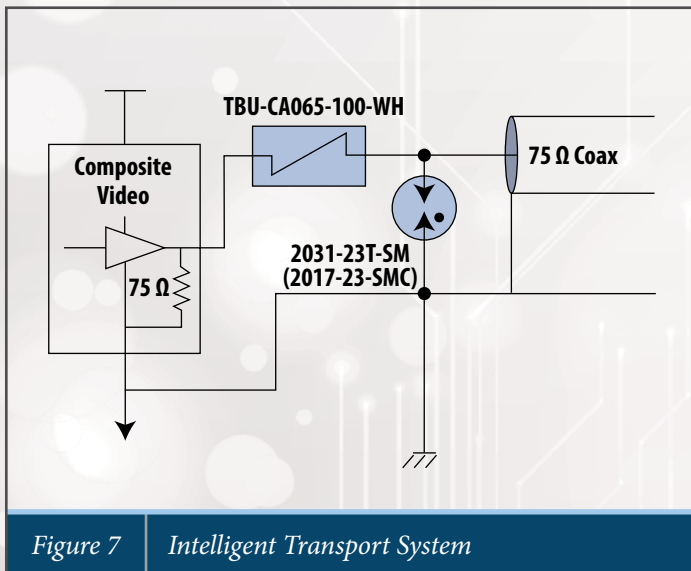


Figure 7 Intelligent Transport System

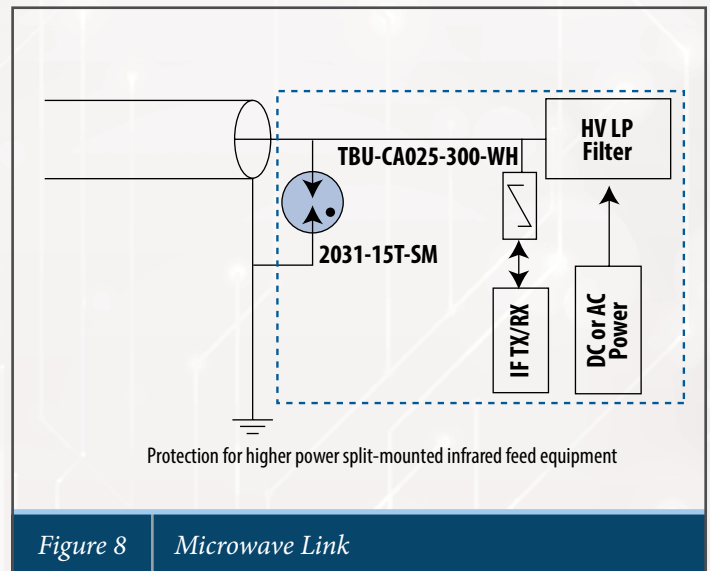


Figure 8 Microwave Link

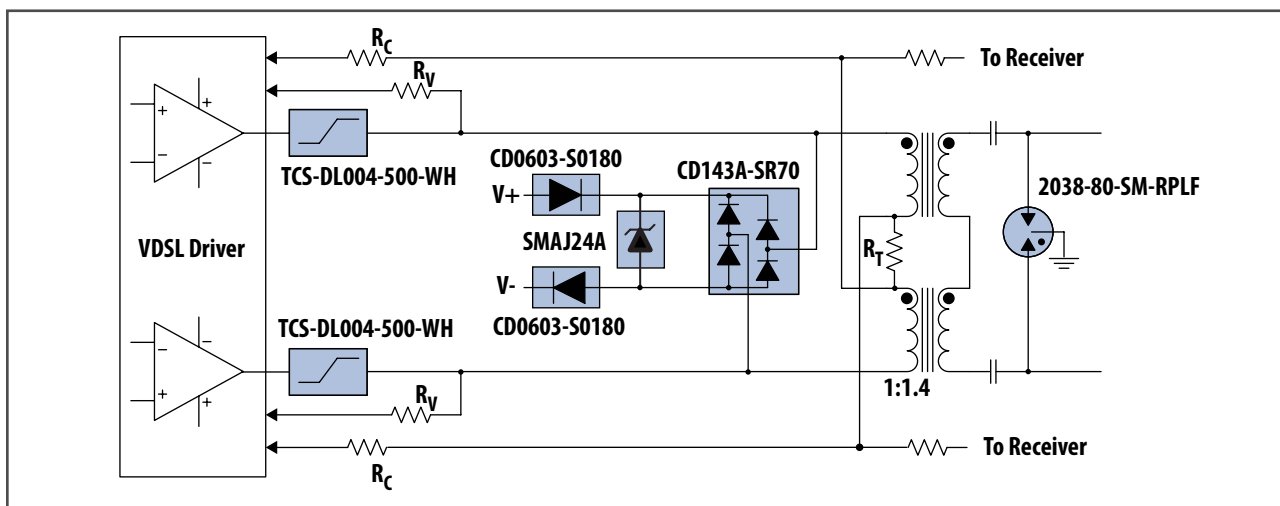


Figure 9 VDSL Class H Driver – Fully Resettable GR-1089 ISSUE 6 Solution for Port Types 1, 3, and 5

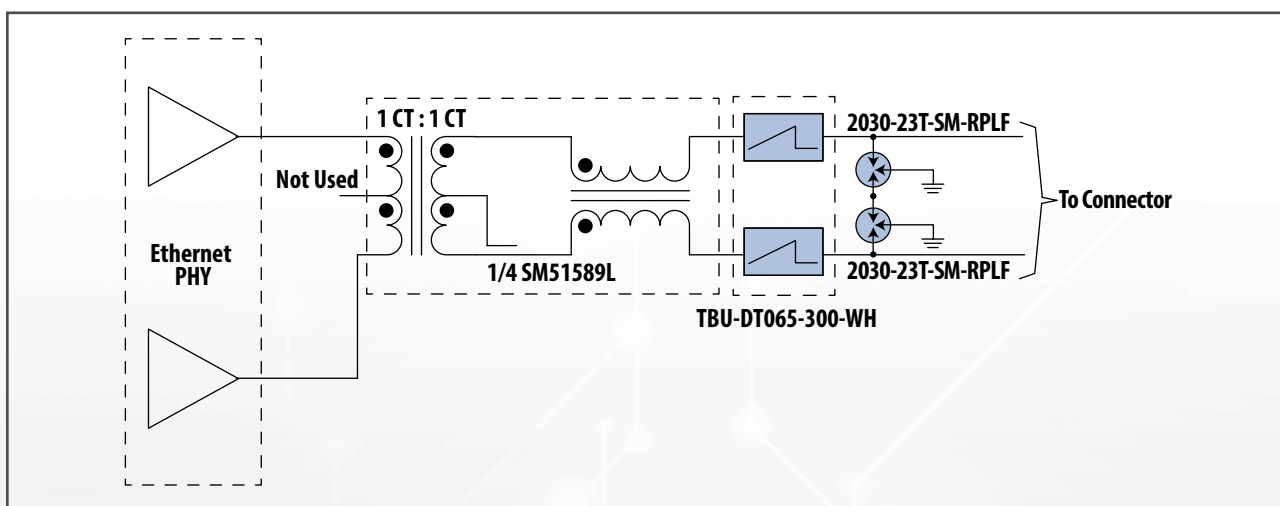


Figure 10 Ethernet Surge and Power Cross Protection – GR-1089 ISSUE 6, Port Type 4

GDT General Information

Quality Systems

Bourns® GDTs* are produced in ISO 9001, ISO 14001 and TS16949 certified facilities.

Quality and Reliable Monitoring

Bourns® GDTs are 100 % production tested to assure compliance of critical product parameters. In addition, GDTs are periodically subjected to ongoing reliability and requalification testing as demanded by our quality system requirements.

Quality Sampling Inspections

Bourns® GDTs are inspected to AQL 0.65, DIN ISO 2859 specifications.

Operating and Storage Conditions

Bourns® GDT devices comply with the general operating and storage conditions as detailed in ITU K.12 (-40 °C to +85 °C) unless otherwise specified in the product series data sheet.

Specific GDT series are offered with an **extended temperature range** for more demanding environments and requirements.

Performance by Design

Bourns® GDT device designs are based on standard ITU-T K.12, as well as key considerations of RUS-PE80/IEEE C62.31, GR-1361, GR-974, GR-1089, ITU-T K.20/21, IEC61643-311 (EN61643-311), and DIN VDE 0845 part 2.

UL Listing

Bourns® GDT are UL recognized to one of the following standards:

- UL 497B
- UL 1449

Information regarding specific products series can be found in the following UL Recognition files:

- E153537
- E313168

Regulated Substances

Bourns® GDTs with an “LF” designator are RoHS compliant as defined in the Annex to 2002/95/EC.

By definition, Bourns® GDTs and Switch-Grade Fail-Short option with an “LF” suffix are below maximum concentration values (no exemptions used) for:

- Lead
- Cadmium
- Hexavalent Chromium
- Mercury and Mercury Compounds
- PBBs and PBDEs

* depending on model type

GDTs with FLAT® Technology

2017-xx-SMC



2-Electrode SMD GDT with FLAT® Technology

Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	90 - 500	10	12	2.5	< 2.5	-55 to +85	Tape & Reel Bulk

2017-xx-SMH



2-Electrode SMD GDT with FLAT® Technology

Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	90 - 500	10	12	2.5	< 2.5	-55 to +85	Tape & Reel Bulk

2018-xx-SMH



3-Electrode SMD GDT with FLAT® Technology

Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	90 - 500	20	24	5	< 2.5	-55 to +105	Tape & Reel

2019-xx-SMH



2-Electrode SMD GDT with FLAT® Technology

Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	90 - 230	20	25	5	< 4	-55 to +105	Tape & Reel

2-Electrode Standard Surface Mount (SMD) GDTs

2003-xx-SM		Light Duty Miniature GDT						
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range ($^{\circ}$ C)	Packaging Options
	see data sheet	75 - 470	1	2	Not Rated	< 0.5	-40 to +90	Tape & Reel
2051-xx-SM		Light Duty Micro Duty GDT - <i>Extended Temperature Range</i>						
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range ($^{\circ}$ C)	Packaging Options
	see data sheet	90 - 600	2	Not Rated	Not Rated	< 1	-40 to +125	Tape & Reel Bulk
2053-xx-SM		Light Duty Miniature GDT						
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range ($^{\circ}$ C)	Packaging Options
	see data sheet	75 - 600	3	5	Not Rated	< 1	-30 to +85	Tape & Reel Bulk
2035-xx-SM		Long Life Medium Duty Miniature GDT						
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range ($^{\circ}$ C)	Packaging Options
	see data sheet	90 - 600	5	10	1	< 1	-55 to +85	Tape & Reel Bulk
2055-xx-SM		Medium Duty Miniature GDT						
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range ($^{\circ}$ C)	Packaging Options
	see data sheet	90 - 600	5	8	Not Rated	< 1	-30 to +85	Tape & Reel Bulk
2027-xx-SM		Long Life Heavy Duty SMD GDT - <i>Extended Temperature Range</i>						
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range ($^{\circ}$ C)	Packaging Options
	see data sheet	75 - 600	10	25	2.5	< 1	-55 to +125	Tape & Reel Bulk
2029-xx-SMLF		Long Life Heavy Duty SMD GDT - <i>Extended Temperature Range</i>						
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range ($^{\circ}$ C)	Packaging Options
	see data sheet	90 - 420	20	25	5	< 1	-55 to +105	Tape & Reel Bulk

2-Electrode Standard Through-Hole GDTs

2057-xx-XX



Medium Duty Through-Hole Micro GDT

Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	75 - 470	5	10	Not Rated	< 1	-40 to +90	Tape & Reel Bulk

2035-xx-XX



Long Life Medium Duty Through-Hole Miniature GDT

Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	90 - 600	5	10	1	< 1	-55 to +85	Tape & Reel Bulk

2037-xx-XX



Long Life Medium Duty Through-Hole Miniature GDT

Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	90 - 600	5	10	1	< 1	-55 to +85	Tape & Reel Bulk

2045-xx-XX



Medium Duty Through-Hole GDT

Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	75 - 470	10	15	Not Rated	< 1.5	-30 to +85	Tape & Reel Bulk

2049-xx-XX



Heavy Duty Through-Hole GDT

Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	75 - 600	15	20	Not Rated	< 1.5	-30 to +85	Tape & Reel Bulk

2027-xx-XX



Long Life Heavy Duty Through-Hole GDT - *Extended Temperature Range*

Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	75 - 600	10	25	2.5	< 1	-55 to +125	Tape & Reel Bulk

2-Electrode High Voltage GDTs

	High Voltage Miniature SMD GDT						
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Operations	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet		800 - 2000	2	3	< 0.5	-30 to +85	Tape & Reel Bulk
	High Voltage Miniature Through-Hole GDT						
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Operations	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet		800 - 1100	2.5	5	< 1	-55 to +85	Tape & Reel Bulk
	High Voltage Miniature SMD GDT						
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Operations	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet		900 - 1100	2.5	5	< 1	-55 to +85	Tape & Reel Bulk
	High Voltage Miniature Through-Hole GDT						
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Operations	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet		1000 - 3600	1.5	3	< 1.5	-30 to +85	Tape & Reel Bulk
	High Voltage SMD GDT						
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Operations	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet		1000 - 3000	3	5	< 0.8	-30 to +85	Tape & Reel Bulk
	High Voltage Through-Hole GDT						
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Operations	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet		800 - 6000	5 / 3	8 / 5	< 1.5	-30 to +90	Tape & Reel Bulk
	Heavy Duty High Voltage Through-Hole GDT						
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Operations	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet		1000 - 2200	20 5 Operations	25	< 1	-30 to +85	Bulk
	High Voltage Through-Hole GDT - <i>Extended Temperature Range</i>						
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Operations	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet		2000 - 7200	5	10	< 1	-40 to +125	Tape & Reel Bulk

2-Electrode High Current GDTs

2047-xx-XX

Long Life High Current Heavy Duty GDT



Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA)	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	90 - 350	40 10 Operations	40	8	< 5	-40 to +90	Bulk

2061-xx-A

High Current Heavy Duty 2-Electrode GDT



Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA)	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	230 - 800	40 5 Operations	60	Not Rated	< 10	-30 to +85	Bulk

2063-xx-A

High Current Heavy Duty 2-Electrode GDT



Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA)	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	230 - 800	60 5 Operations	100	Not Rated	< 10	-30 to +85	Bulk

Powerline GDT

2033-xx-A

Powerline GDT



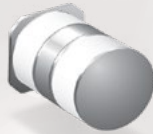
Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA)	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	800 - 1400	20, 10 Operations	N/A	4	< 1	-40 to +125	Tape & Bulk

3-Electrode Standard SMD GDTs

2052-xx-SM Light Duty Symmetrical Miniature SMD GDT								
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications*	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application*	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range ($^{\circ}$ C)	Packaging Options
	see data sheet	230 - 600	5	10	Not Rated	< 2	-30 to +85	Tape & Reel, Bulk
2054-xx-SM Light Duty Miniature SMD GDT								
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications*	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application*	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range ($^{\circ}$ C)	Packaging Options
	see data sheet	230 - 470	5	Not Rated	Not Rated	< 2	-30 to +85	Tape & Reel, Bulk
2038-xx-SM Long Life Light Duty Symmetrical Miniature SMD GDT								
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications*	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application*	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range ($^{\circ}$ C)	Packaging Options
	see data sheet	150 - 600	5	10	Not Rated	< 1	-40 to +90	Tape & Reel, Bulk
2036-xx-SM Long Life Medium Duty Miniature SMD GDT - <i>Extended Temperature Range</i>								
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications*	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application*	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range ($^{\circ}$ C)	Packaging Options
	see data sheet	75 - 600	10	20	2	< 2	-55 to +105	Tape & Reel, Bulk
2036-xx-SM-H Long Life Medium Duty Miniature SMD GDT - <i>High Temperature Range</i>								
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications*	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application*	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range ($^{\circ}$ C)	Packaging Options
	see data sheet	75 - 600	10	20	2	< 2	-55 to +125	Tape & Reel, Bulk

*The rated current is the total current equally divided between each line to ground (ELTG).

3-Electrode High Voltage SMD GDTs

2052-xx-SM High Voltage Symmetrical Miniature SMD GDT								
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications*	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application*	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range ($^{\circ}$ C)	Packaging Options
	see data sheet	800	5	10	Not Rated	< 2	-30 to +85	Tape & Reel
2038-xx-SM High Voltage Symmetrical Miniature SMD GDT								
	Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications*	Maximum 8 x 20 μ s Impulse Current (kA) 1 Application*	Maximum 10 x 350 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range ($^{\circ}$ C)	Packaging Options
	see data sheet	800, 1100	5	10	Not Rated	< 1	-40 to +90	Tape & Reel, Bulk

3-Electrode Standard Through-Hole GDTs

2056-xx-XX

Light Duty Through-Hole GDT



Size (mm)	Optional Fail-Short	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications*	Max. 8 x 20 μ s Impulse Current (kA) 1 Application*	Max. 10 x 350 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	Yes	90 - 600	5	Not Rated	Not Rated	< 2	-30 to +85	Bulk

2046-xx-XX

Medium Duty Through-Hole GDT



Size (mm)	Optional Fail-Short	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications*	Max. 8 x 20 μ s Impulse Current (kA) 1 Application*	Max. 10 x 350 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	Yes	90 - 600	10	20	Not Rated	< 2	-30 to +85	Bulk

2036-xx-XX

Long Life Medium Duty Miniature Through-Hole GDT - *Extended Temperature Range*



Size (mm)	Optional Fail-Short	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications*	Max. 8 x 20 μ s Impulse Current (kA) 1 Application*	Max. 10 x 350 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	Yes Switch-Grade	75 - 600	10	20	2	< 2	-55 to +105	Bulk

2026-xx-XX

Long Life Heavy Duty Through-Hole GDT



Size (mm)	Optional Fail-Short	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications*	Max. 8 x 20 μ s Impulse Current (kA) 1 Application*	Max. 10 x 350 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	Yes Switch-Grade	75 - 600	20	40	5	< 2	-40 to +90	Bulk

2026-xx-XX-MSP

Heavy Duty Multi-Stage Through-Hole GDT



Size (mm)	Optional Fail-Short	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications*	Max. 8 x 20 μ s Impulse Current (kA) 1 Application*	Max. 10 x 350 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
see data sheet	Yes Switch-Grade	300 - 400	20	40	5	< 20	-55 to +85	Bulk

*The rated current is the total current equally divided between each line to ground (ELTG).

2-Electrode & 3-Electrode Fast Acting GDTs

Fast Acting GDT Devices

Bourns has developed a line of fast acting GDTs designed specifically for use with the Bourns® TBU® High-Speed Protector (HSP). These fast acting GDT are designed to limit high-speed impulse voltages to levels below the TBU® HSP peak voltage impulse rating (V_{imp}). Voltages exceeding the TBU® HSP V_{imp} rating may cause damage to the TBU® HSP.

The fast acting GDT and TBU® HSP provide an extremely fast, low voltage let-through protection solution that is well-suited to sensitive electronics susceptible to damage from voltage and current transients.

Fast Acting GDT Advantages

- Designed specifically for the TBU® HSP
- Simplifies designing with the TBU® HSP
- Extremely fast overvoltage protection limiting surges below the V_{imp} of the TBU® HSP
- Low capacitance, making it ideal for high-speed applications
- 2-electrode and 3-electrode designs available
- Optional Switch-Grade Fail-Short available for Model 2030-xxT-SM

2020-xxT Fast Acting 3-Electrode Miniature Through-Hole GDT							
	Size (mm)	Optional Fail-Short	Min. DC Breakdown Range (V)	Max. 8 x 20 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
	see data sheet	No	60 - 360	10	< 1	-40 to +90	Bulk
2030-xxT-SM Fast Acting 3-Electrode Miniature SMD GDT - <i>with optional Fail-Short</i>							
	Size (mm)	Optional Fail-Short	Min. DC Breakdown Range (V)	Max. 8 x 20 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
	see data sheet	Yes	185, 360	4	< 1	-40 to +90	Tape & Reel Bulk
2031-xxT-SM Fast Acting 2-Electrode Miniature SMD GDT							
	Size (mm)	Optional Fail-Short	Min. DC Breakdown Range (V)	Max. 8 x 20 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
	see data sheet	No	60 - 360	1	< 1	-40 to +90	Tape & Reel Bulk
2011-xxT-SM Fast Acting 2-Electrode SMD GDT with FLAT® Technology							
	Size (mm)	Optional Fail-Short	Min. DC Breakdown (V)	Max. 8 x 20 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range (°C)	Packaging Options
	see data sheet	No	60	1	< 2.9	-40 to +90	Tape & Reel Bulk

* End of life value for DC breakdown. Fresh devices will have significantly higher DC breakdown when measured.

Next-Generation Fast Acting GDT

GDT25-xx-S1

Next-Generation Fast Acting GDT



Size (mm)	DC Breakdown Range (V)	Nominal 8/20 μ s Impulse Discharge Current (kA) 10 Applications*	Max. 8 x 20 μ s Impulse Current (kA) 1 Application*	Max. 10 x 350 μ s Impulse Current (kA) 1 Application*	Capacitance (pF)	Operating Temperature Range ($^{\circ}$ C)	Packaging Options
see data sheet	75, 90, 350, 600	5: (75V & 90V) 7: (350V and 600V)**	10	1	< 0.7	-55 to +125	Bulk, Tape and Reel

GDTs in Evaluation Boards

This evaluation board serves as an aid in evaluating circuit protection on RS-485 serial device ports using two Bourns® TBU® High-Speed Protectors (HSPs), two fast acting GDTs and two TVS diodes to meet the required industry standards on RS-485 port interfaces. The recommended Bourns® TBU® HSP solution with a low capacitance GDT offers enhanced high-speed performance features over competing technologies, which can help the design engineer increase the surge and transient protection level on RS-485 ports and place the entire circuit protection solution into a smaller reduced PCB area. Bourns has developed an RS-485 evaluation board (measuring 45 mm x 21 mm x 1.2 mm), manufactured using FR4 PCB with nickel gold plating on the top and bottom sides.

** The default configuration of this board uses 2 GDTs (GDT1, GDT2) and discrete SMB TVS diodes (TVS1, TVS2). The board allows different configurations:

- 2 single 2031 GDTs (GDT1 and GDT2) may be replaced by a 2030 GDT (GDT3).
- 2 SMB TVS diodes (TVS1 and TVS2) may be replaced with a) two SOT23 TVS diodes (TVS3, TVS4) or b) a single TVS diode array (TVS5).

See Bourns website for latest updates on evaluation boards and applications notes

RS-485 Evaluation Board Top Side Layout**

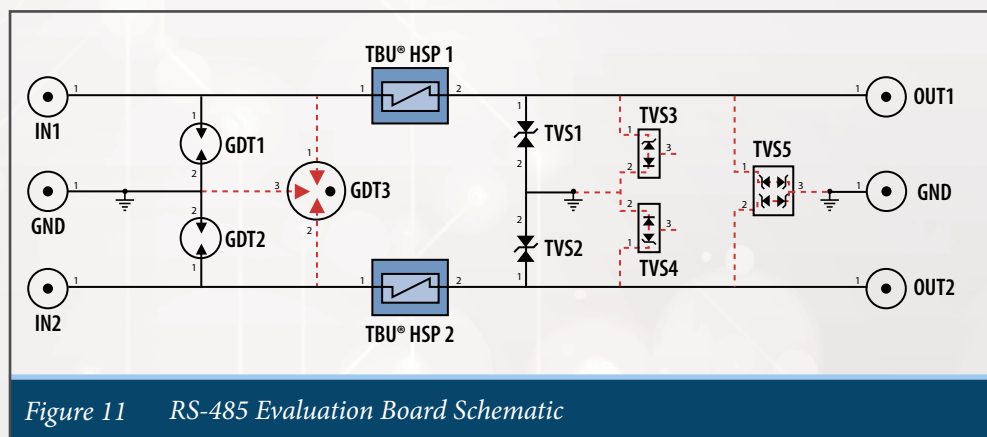
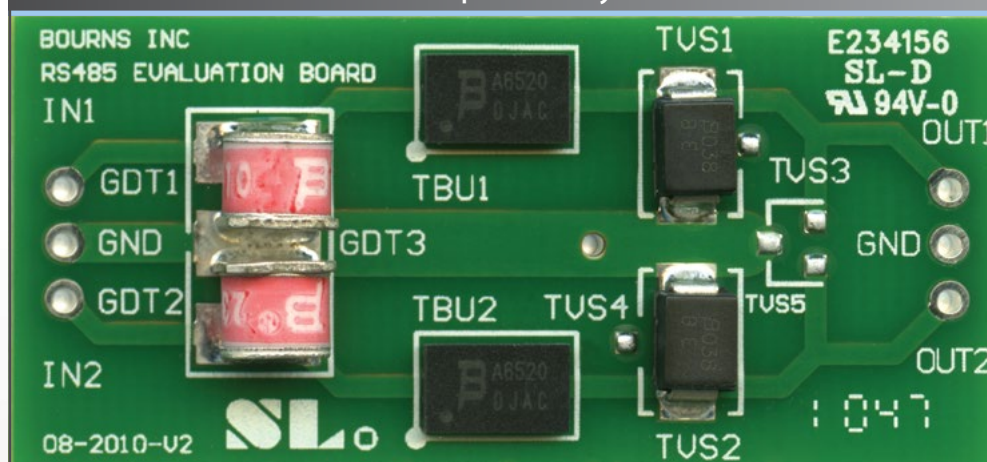
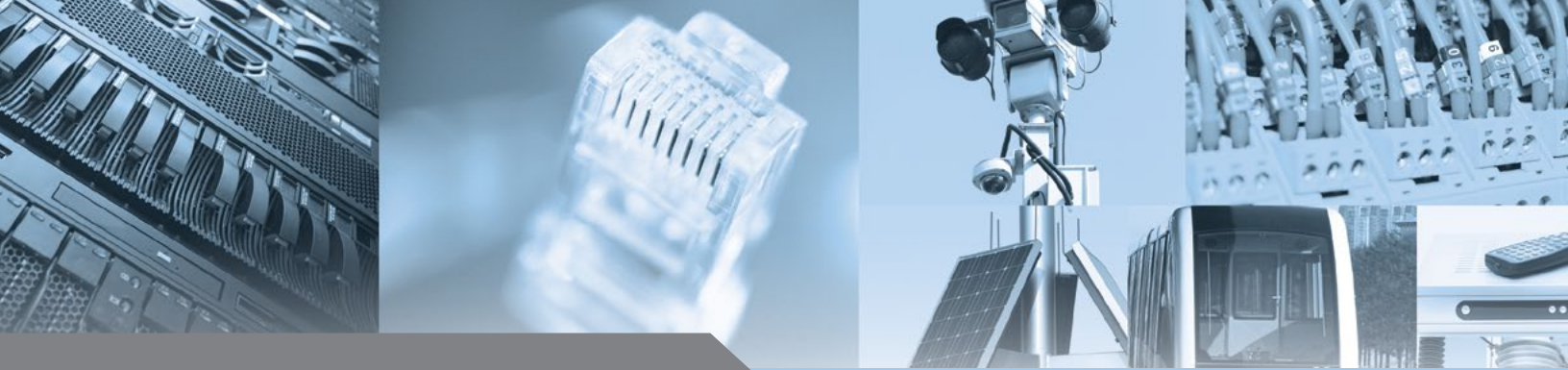


Figure 11 RS-485 Evaluation Board Schematic



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